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CTR215-M4

4-Pin Mini-Flat DMC-Isolator®

PhotoMOS Relays

Features

- High isolation 3750 V_{RMS}
- OFF-state output terminal voltage: 100 V
- Typical ON-state resistance: 0.6 Ω
- Operating Temperature range - 40 °C to 85 °C
- Creepage distance ≥ 5mm
- Distance Through Isolation > 0.4mm
- RoHS and REACH Compliance
- Halogen Free Compliance
- MSL class 1
- Regulatory Approvals
  - ✓ UL - UL1577 (E364000)
  - ✓ VDE - EN60747-5-5(VDE0884-5)
  - ✓ CQC – GB4943.1, GB8898 (14001105803)
  - ✓ IEC62368 (FI/41119)

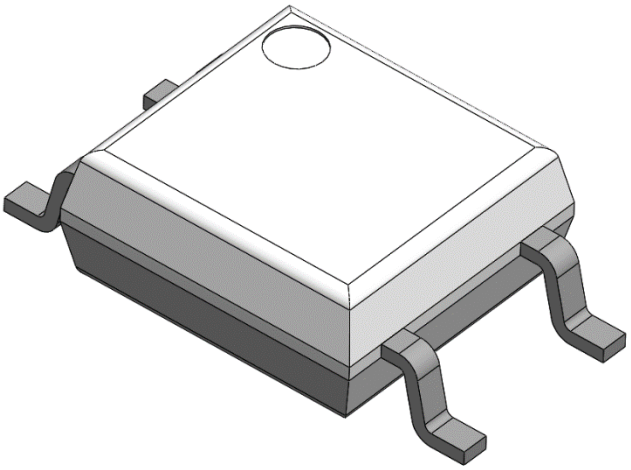
Description

The CTR215-M4 (1-form-A) consists of two MOSFET and one photovoltaic chip optically coupled to an Infrared-emitting diode in 4-lead Mini-Flat package.

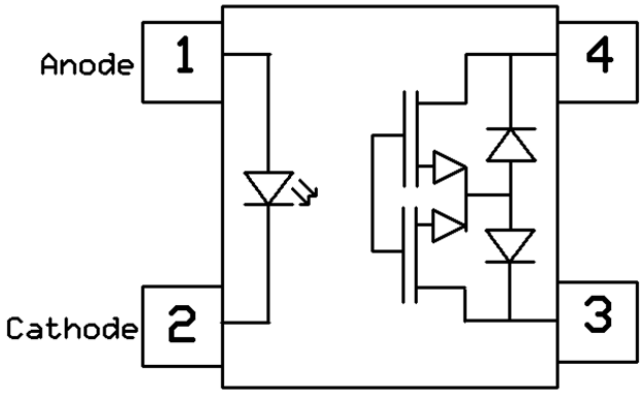
Applications

- Battery Management System (BMS)
- Security Systems
- Smart Meters
- Mechanical relay replacements
- General telecom switching
- Industrial controls
- Automatic measurement equipment

Package Outline



Schematic



Absolute Maximum Ratings T_A = 25°C, unless otherwise specified

Stresses in excess of the absolute maximum ratings can cause permanent damage to the device. Functional operation of the device is not implied at these or any other conditions in excess of those given in the operational sections of this document. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only.

Symbol	Parameters	Ratings	Units	Notes
V_{ISO}	Isolation voltage (AC, 1 minute, 40 ~ 60% R.H.)	3750	Vrms	
T_{OPR}	Operating temperature	-40 ~ +85	°C	
T_{STG}	Storage temperature	-40 ~ +100	°C	
T_{SOL}	Soldering temperature (For 10 seconds)	260	°C	
Emitter				
I_F	Forward current	50	mA	
$I_{F(TRANS)}$	Peak transient current (≤1μs P.W,300pps)	1	A	
V_R	Reverse voltage	5	V	
P_C	Power dissipation	85	mW	
T_j	Junction Temperature	115	°C	
Detector				
V_{OFF}	OFF-state output terminal Voltage	100	V	
I_{ON}	ON-state Current	0.5	A	
P_o	Output Power dissipation	375	mW	
T_j	Junction Temperature	125	°C	
T_{jA}	Junction to Ambient Temperature	60	°C	

Recommended Operating Conditions

Symbol	Parameters	Min	Typ	Max	Units
V_{DD}	Supply Voltage	-	-	80	V
I_{FT}	Trigger LED Current	5	10	20	mA
T_{OPR}	Operating temperature	-40	-	60	℃

Electrical Characteristics *T_A = 25°C, unless otherwise specified*

Emitter Characteristics

Symbol	*Parameters*	*Test Conditions*	*Min*	*Typ*	*Max*	*Units*	*Notes*
V_F	Forward voltage	I_F = 10mA	-	1.4	1.6	V	
I_R	Reverse Current	V_R = 6V	-	-	5	μA	
C_{IN}	Input Capacitance	f= 1MHz	-	30	-	pF	

Detector Characteristics

Symbol	*Parameters*	*Test Conditions*	*Min*	*Typ*	*Max*	*Units*	*Notes*
I_{OFF}	OFF-state Current	V_{OFF} =100V	-	-	1	uA	
C_{OFF}	Output Capacitance	V_O= 0V, f=1 MHz	-	30	-	pF	

Transfer Characteristics

Symbol	*Parameters*	*Test Conditions*	*Min*	*Typ*	*Max*	*Units*	*Notes*
I_{FT}	Trigger LED Current	I_{ON} =Max	-	1.5	3	mA	
R_{ON}	ON-state resistance	I_{ON} =Max, I_F =5 mA , t < 1s	-	0.6	1.5	Ω	

Switching Characteristics

Symbol	*Parameters*	*Test Conditions*	*Min*	*Typ*	*Max*	*Units*	*Notes*
T_{ON}	Turn-on Time	R_L=200Ω, V_{DD}=20V, I_F=5mA	-	1	3	ms	
T_{OFF}	Turn-off Time	f=100Hz	-	0.3	2	ms	

Typical Characteristic Curves *T_A = 25°C, unless otherwise specified*

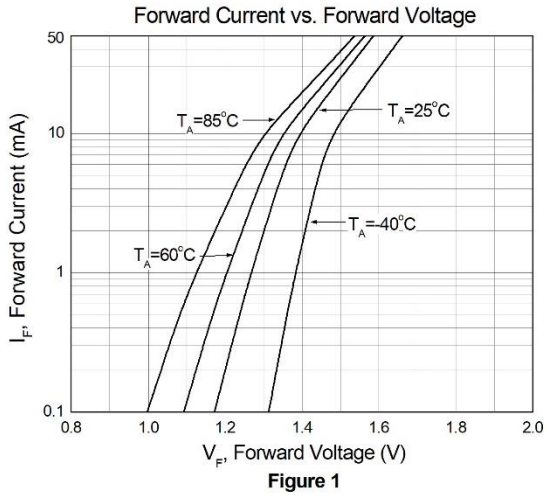


Figure 1

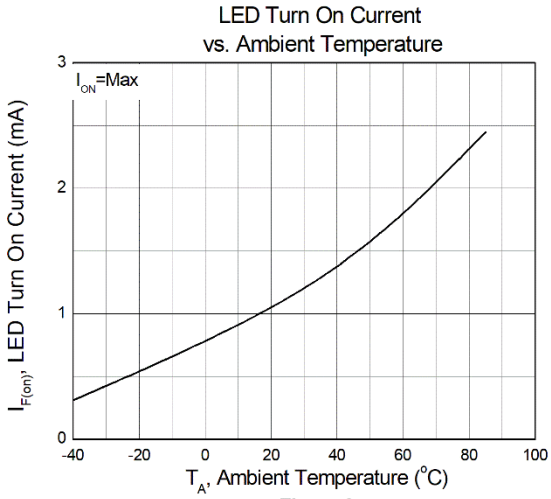


Figure 2

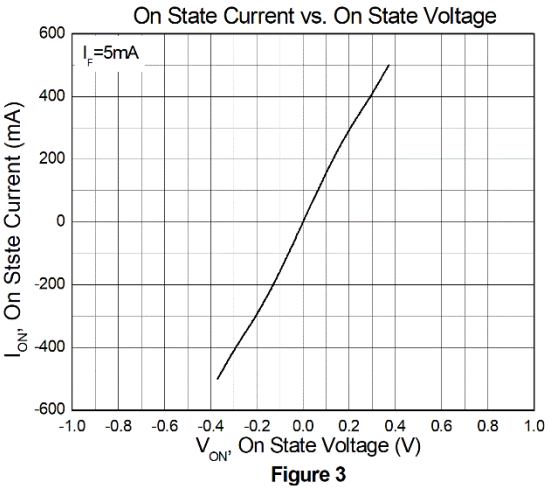


Figure 3

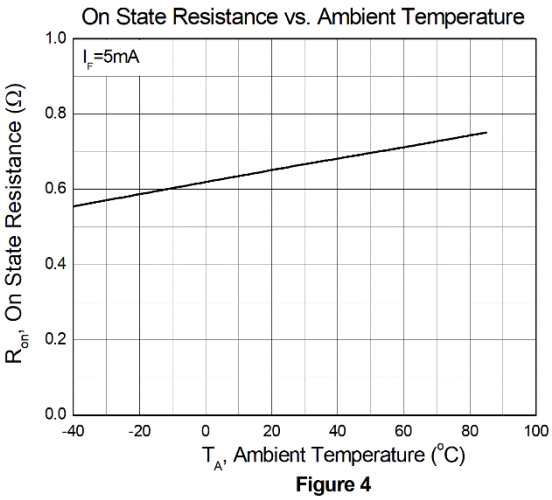


Figure 4

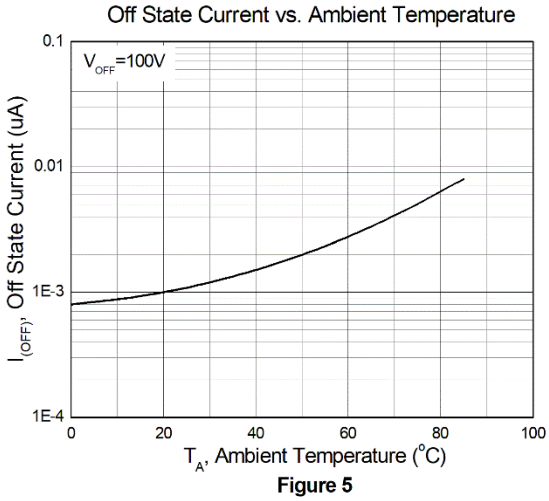


Figure 5

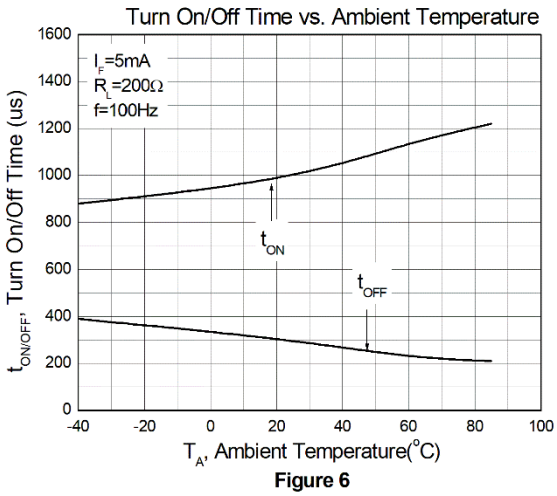


Figure 6

Typical Characteristic Curves *T_A = 25°C, unless otherwise specified*

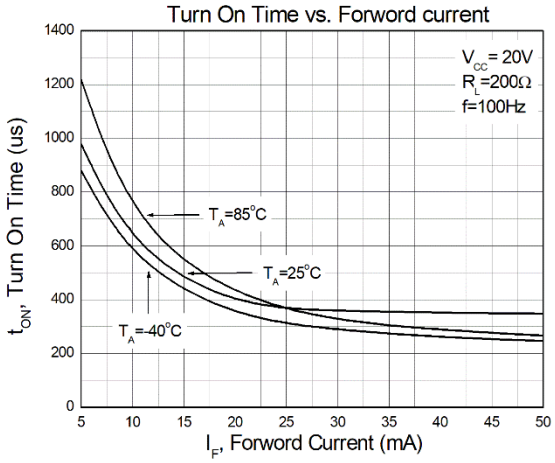


Figure 7

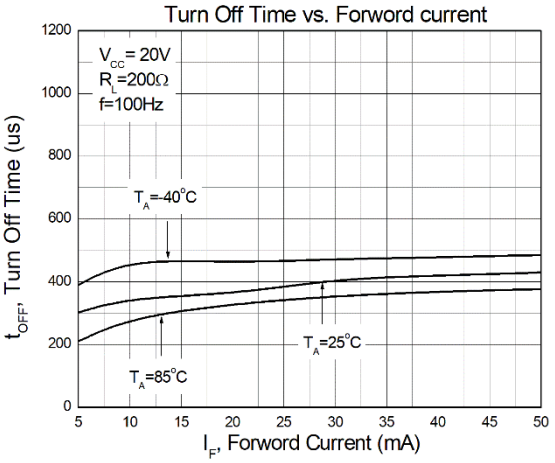


Figure 8

Test Circuit

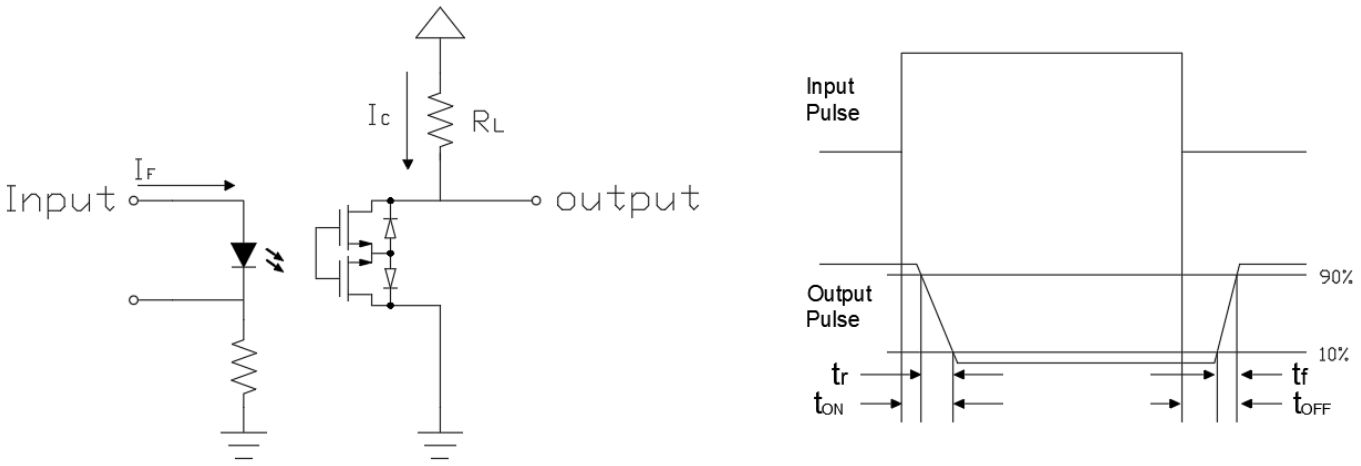
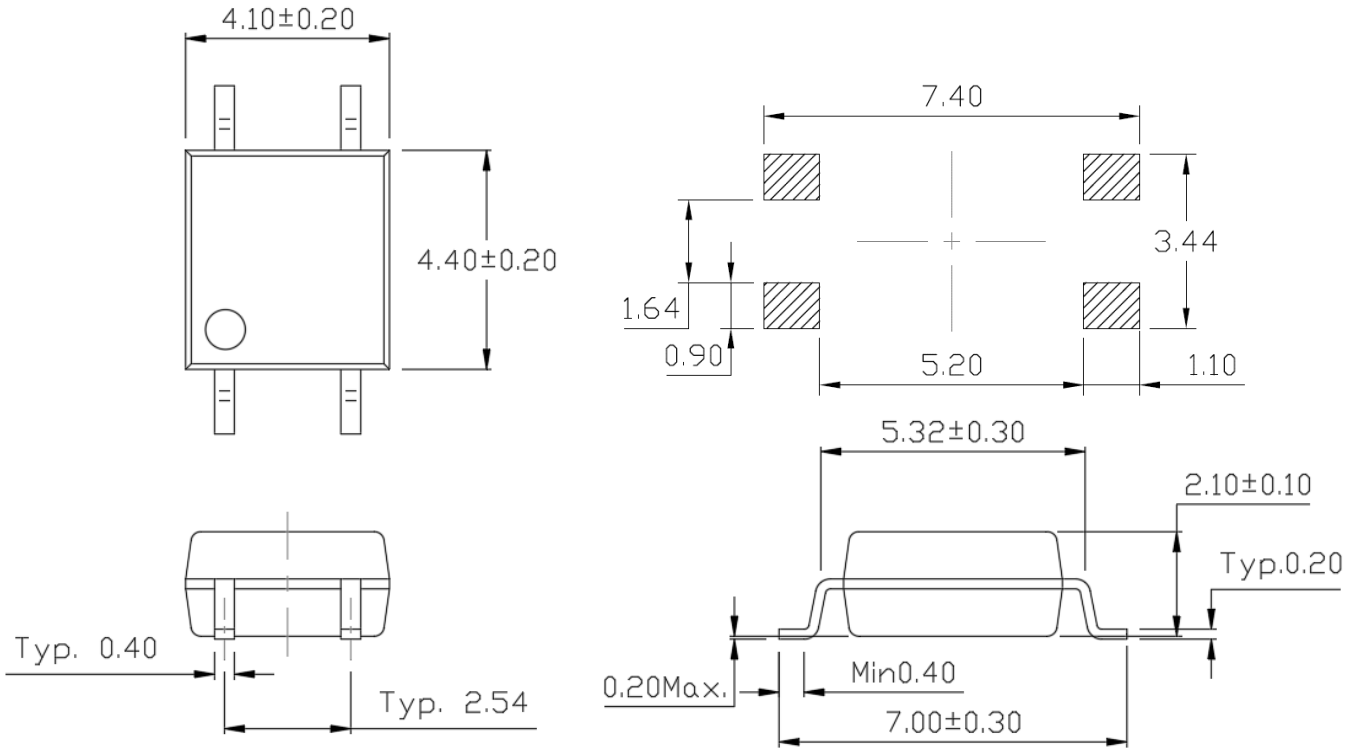
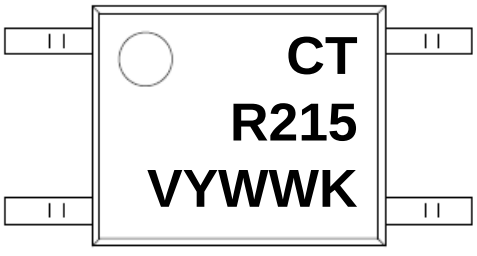


Figure 9: Switching Time Test Circuits

Package Dimension *Dimensions in mm unless otherwise stated*



Marking Information



Note:

CT	: Denotes “CT Micro”
R215	: Part Number
X	: Option (Blank, A or B)
V	: VDE Safety Mark Option (Blank or V)
Y	: One Digit Year Code
WW	: Two Digit Work Week
K	: Manufacturing Code

Ordering Information

CTR215(V)(Z)-M4

CT = Denotes “CT Micro”

R215 = Part Number

V = VDE Safety Mark Option (Blank or V)

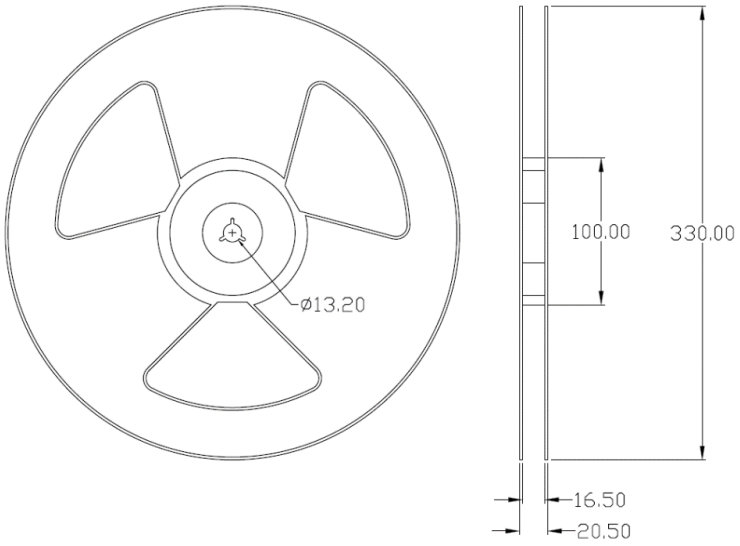
Z = Tape and Reel Option (T1 or T2)

M4 = MFP Package

Option	*Description*	*Quantity*
T1	Surface Mount Lead Forming – With Option 1 Tapping	3000 Units/Reel
T2	Surface Mount Lead Forming – With Option 2 Tapping	3000 Units/Reel

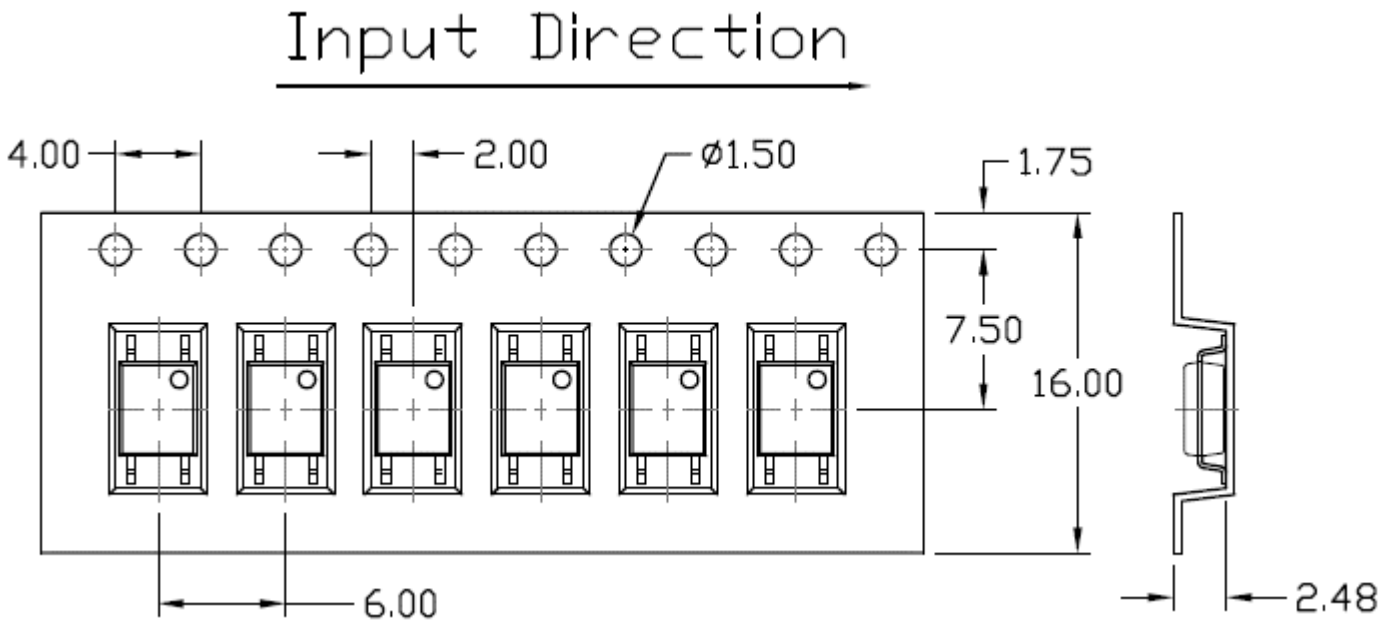
Reel Dimension *All dimensions are in mm, unless otherwise stated*

Option T1/T2

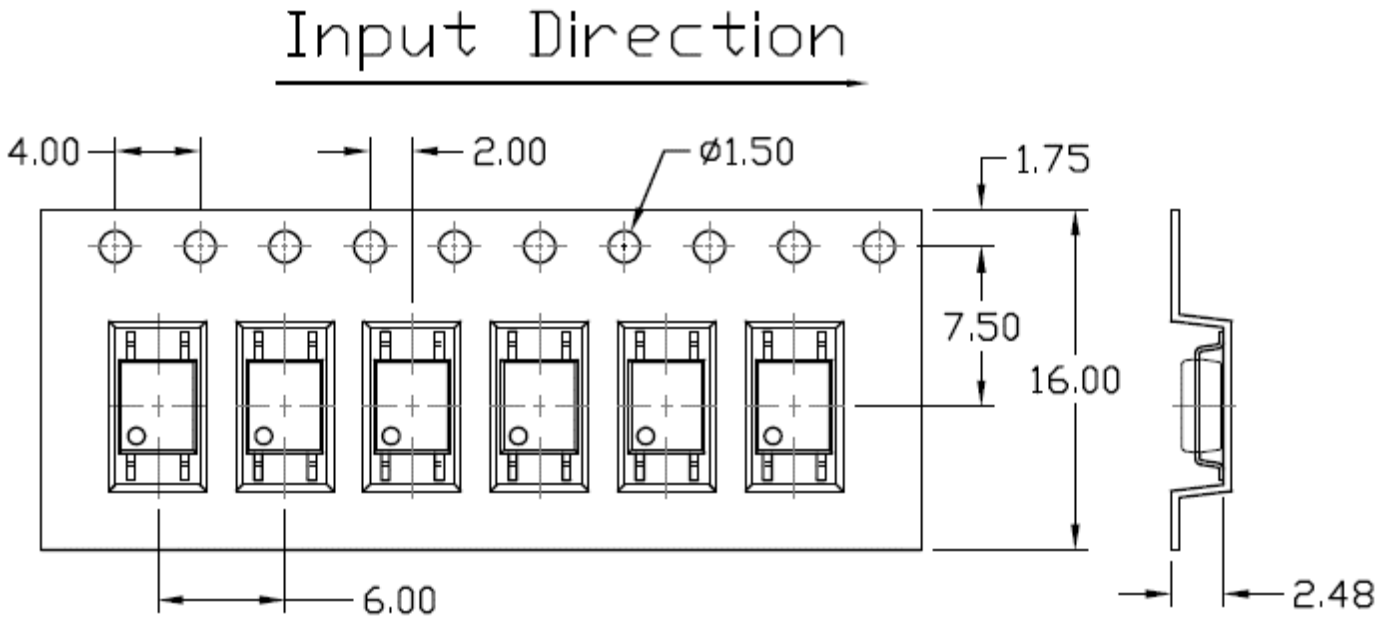


Carrier Tape Specifications *Dimensions in mm unless otherwise stated*

Option T1



Option T2

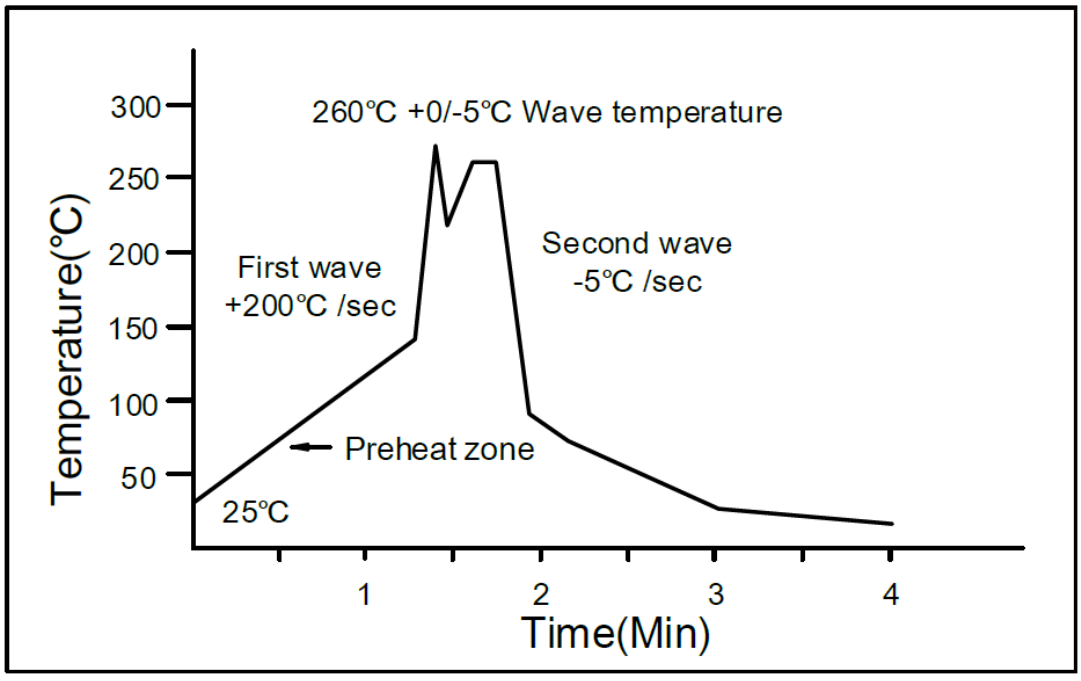


Solderability spec (Follow the JEDEC standard JESD22-B102)

Reflow Soldering: Immersed surface, other than the end of pin as cut-surface, must be covered by solder.
Solder-Bath: More than 95% of the electrode must be covered with solder.

Wave soldering (Follow the JEDEC standard JESD22-A111)

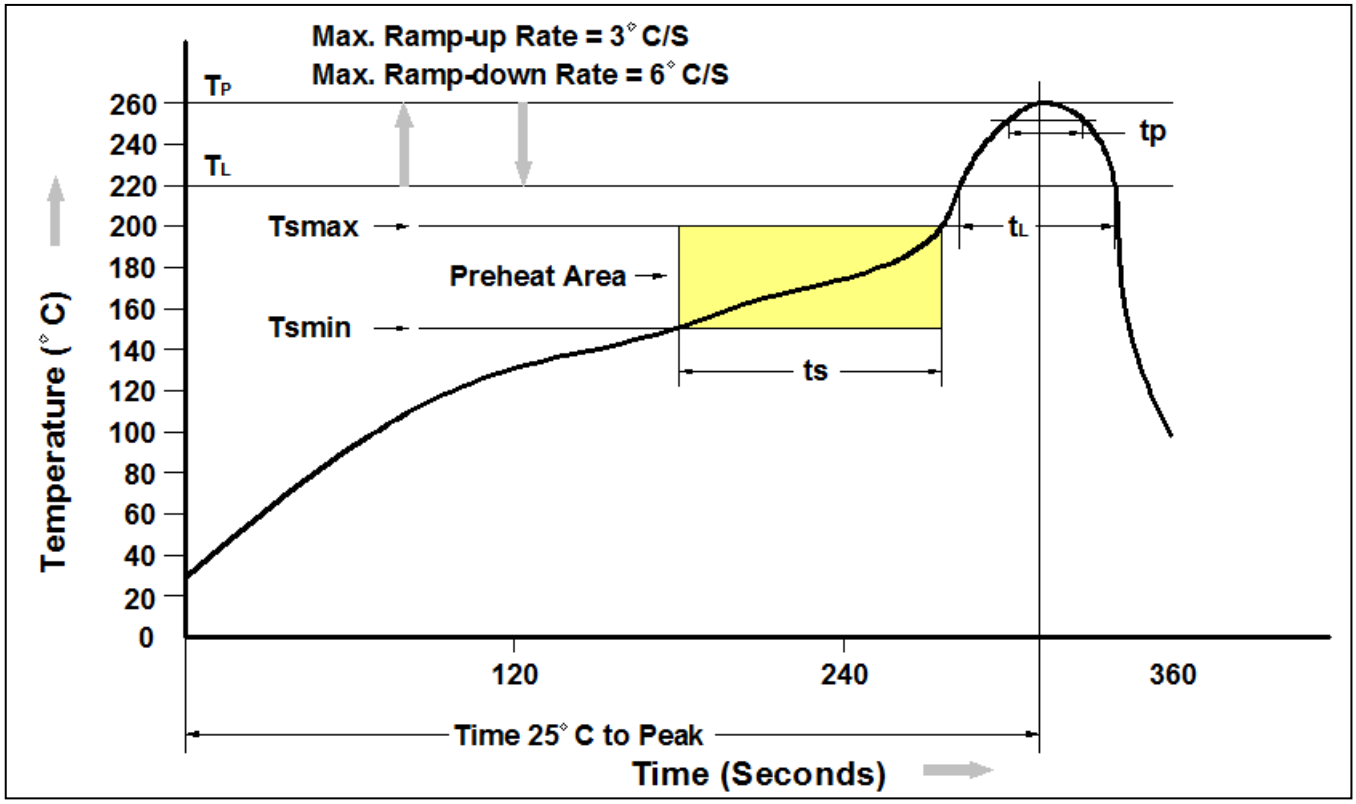
One time soldering is recommended within the condition of temperature.
Temperature: 260+0/-5˚C.
Time: 10 sec.
Preheat temperature: 25 to 140˚C.
Preheat time: 30 to 80 sec.



Iron soldering (Follow the standard MIL-STD 202G, Method 210F)

Allow single lead soldering in every single process.
One time soldering is recommended. Temperature: 350±10˚C
Time: 5 sec max.

Reflow Profile (Follow the JEDEC standard J-STD-020)



Profile Feature	Pb-Free Assembly Profile
Temperature Min. (Tsmin)	150°C
Temperature Max. (Tsmax)	200°C
Time (ts) from (Tsmin to Tsmax)	60-120 seconds
Ramp-up Rate (t_L to t_P)	3°C/second max.
Liquidous Temperature (T_L)	217°C
Time (t_L) Maintained Above (T_L)	60 – 150 seconds
Peak Body Package Temperature	260°C +0°C / -5°C
Time (t_P) within 5°C of 260°C	30 seconds
Ramp-down Rate (T_P to T_L)	6°C/second max
Time 25°C to Peak Temperature	8 minutes max.

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